IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Ap	plication of:)	
YOSHI	MASA OKAMURA, ET AL.	;	
Applica	tion No.: Not Yet Assigned	;	
Filed: I	Herewith)	
For:	FABRICATION OF NANOSCALE THERMOELECTRIC DEVICES	;) :	November 24, 2003

Mail Stop Patent Application Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

INFORMATION DISCLOSURE STATEMENT

Sir:

In compliance with the duty of disclosure under 37 C.F.R. § 1.56 and in accordance with the practice under 37 C.F.R. §§ 1.97 and 1.98, the Examiner's attention is directed to the documents listed below and on the enclosed Forms PTO-1449. A copy of each document so listed is enclosed.

- (1) U.S. Patent Publication No. 2002/0158342
- (2) U.S. Patent Publication No. 2002/0170590
- (3) U.S. Patent Publication No. 2003/0041892
- (4) U.S. Patent Publication No. 2003/0047204
- (5) U.S. Patent No. 4,971,632
- (6) U.S. Patent No. 4,983,225
- (7) U.S. Patent No. 5,286,304
- (8) U.S. Patent No. 5,581,091
- (9) U.S. Patent No. 5,837,929

- (10) U.S. Patent No. 5,921,087
- (11) U.S. Patent No. 6,127,619
- (12) U.S. Patent No. 6,207,887
- (13) U.S. Patent No. 6,214,738
- (14) U.S. Patent No. 6,231,744
- (15) U.S. Patent No. 6,232,542
- (16) U.S. Patent No. 6,359,288
- (17) U.S. Patent No. 6,441,295
- (18) U.S. Patent No. 6,441,296
- (19) U.S. Patent No. 6,605,772
- (20) JP 63-020880
- (21) JP 11-298051
- (22) JP 2001-282396
- (23) WO 03/077298
- (24) "Introduction to Thermoelectrics", website, http://www.thermoelectrics.com/introduction.htm, site visited July 28, 2003.
- (25) M.S. Dresselhaus, et al., "The Promise of Low Dimensional Systems for Thermoelectric Applications," website, http://www.osti.gov/fcvt/darpa2002/mdresselhaus.pdf site visited September 18, 2003.
- (26) "THERMOELECTRICITY" website, http://www.nanothermel.org/public_main.htm, site visited July 28, 2003.
- (27) "Stacy Group" Stacy Group Thermoelectrics
 Research, website,
 http://www.cchem.berkeley.edu/~amsgrp/thermoelectrics.html, site visited August 29, 2003.
- (28) "Design of Advanced Materials" Stacy Group Home, website, http://www.cchem.berkeley.edu/~amsgrp/index.html, site visited July 28, 2003.

- (29) "Eneco Technology" r-layout2, website, http://www.eneco-usa.com/technology/content.htm, site visited July 28, 2003.
- (30) "Hi-Z Technology" Hi-Z TECHNOLOGY, INC., website, http://www.hi-z.com/, site visited July 28, 2003.
- (31) "Marlow Industries Inc." thermoelectric manufacturer Marlow Industries inc., website, http://www.marlow.com/, site visited July 28, 2003.
- (32) "TELLUREX Z-Max thermoelectric modules for power generation..." Tellurex Corporation, website, http://www.tellurex.com/, site visited July 28, 2003.
- (33) "A Quantum Leap in Power Generation" Power Chips plc, website, http://www.powerchips.gi/, site visited July 28, 2003.
- (34) "The Science Behind Power ChipsTM, A Basic Introduction" Power Chips plc, website, http://www.powerchips.gi/technology/overview.shtml site visited July 28, 2003.
- (35) M.S. Dresselhaus, et al., "INVESTIGATION OF LOW-DIMENSIONAL THERMOELECTRICS", Symposium Proceeding, Technomoic Publishing Co., pp. 1-13.
- (36) M.S. Dresselhaus, et al., "NANOWIRES FOR THERMOELECTRIC APPLICATIONS", Massachusetts Institute of Technology.

No copies of the cited U.S. Patents are being provided, in accordance with the Pre-Official Gazette Notice dated July 11, 2003, entitled "Information Disclosure Statements Filed Without Copies of U.S. Patents and Published Applications in Patent Applications filed after June 30, 2003." Copies of the non-U.S. patent documents are provided.

Inasmuch as the subject application has not yet received a first Office Action, it is believed that this Information Disclosure Statement is timely. See 37 C.F.R. 1.97(b)(3). Accordingly, the Examiner is urged to study this information in its entirety and

to form an independent determination of the materiality of the information to the claimed invention. Additionally, the Examiner is requested to indicate that the enclosed information has been considered by initialing the appropriate portion of Forms PTO-1449.

Applicants' undersigned attorney may be reached in our Costa Mesa, California office by telephone at (714) 540-8700. All correspondence should continue to be directed to our address given below.

Respectfully submitted,

Attorney for Applicants

Registration No. 54336

FITZPATRICK, CELLA, HARPER & SCINTO 30 Rockefeller Plaza New York, New York 10112-3801

Facsimile: (212) 218-2200

FORM PTO 1449 (modified) U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE LIST OF REFERENCES CITED BY APPLICANT(S) (Use several sheets if necessary)		ATTY DOCKET NO. 03650.002191. APPLICATION NO. N/Y/A					
		APPLICANT YOSHIMASA OKAMURA, ET AL.					
		FILING DATE HEREWITH		GROUP N/Y/A			
			U.S. PATENT DOCUMENTS				
*EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE	
	2002/0158342	10/31/02	Tuominen, et al	428	195		
	2002/0170590	11/21/02	Heremans, et al.	136	240		
	2003/0041892	03/06/03	Parsons, et al.	136	200		
	2003/0047204	03/13/03	Fleurial, et al.	136	200		
	4,971,632	11/20/1990	Rowe	136	212		
	4,983,225	01/08/1991	Rowe	136	201		
	5,286,304	02/15/1994	Macris, et al.	136	201		
	5,581,091	12/03/96	Moskovits et al.	257	9		
	5,837,929	11/17/1998	Adelman	136	225		
	5,921,087	07/13/1999	Bhatia, et al.	62	3.2	<u> </u>	
	6,127,619	10/03/2000	Xi, et al.	136	203		
	6,207,887	03/27/2001	Bass, et al.	136	201		
	6,214,738	04/10/2001	Aiba, et al.	438	707		
FOREIGN PATENT DOCUMENTS							
	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION YES/NO/ OR ABSTRACT	
	63-20880	01/28/1988	JAPAN			Abstract	
	11-298051	10/29/1999	JAPAN			Abstract	
	2001-282396	10/12/2001	JAPAN			Abstract	
	03/077298	09/18/03	РСТ				
	. 0	THER DOCUMENT(S	s) (Including Author, Title, Date, Pertinent Pages, Etc.)				

DATE CONSIDERED

Sheet_1_ of 3_

EXAMINER

^{*}EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

FORM PTO 1449 (modified)			ATTY DOCKET NO. 03650.002195. APPLICATION NO. N/Y/A					
U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE		APPLICANT YOSHIMASA OKAMURA						
	EFERENCES CITED BY A se several sheets if nece		FILING DATE HEREWITH GROUP N/Y/A					
			U.S. PATENT DOCUMENTS					
*EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE		
	6,231,744	05/15/2001	Ying, et al.	205	324			
	6,232,542	05/15/2001	Hiraishi, et al.	136	201			
	6,359,288	03/19/2002	Ying, et al.	257	14			
	6,441,295	08/27/2002	Hiraishi, et al.	136	201			
	6,441,296	08/27/2002	Hiraishi, et al.	136	201			
	6,605,772	08/12/2003	Harman, et al.	136	236.1			
			,					
			FOREIGN PATENT DOCUMENTS		, , , , , , , , , , , , , , , , , , , 			
	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION YES/NO/ OR ABSTRACT		
		OTHER DOCUMEN	NT(S) (Including Author, Title, Date, Pertinent Pages, Etc.)					
	"Introduction visited July 28		rics", website, http:/www.thermoelec	trics.com/int	roduction.l	<u>ntm</u> , site		
	M.S. Dressell Applications,' 18, 2003.	M.S. Dresselhaus, et al., "The Promise of Low Dimensional Systems for Thermoelectric Applications," website, http://www.osti.gov/fcvt/darpa2002/mdresselhaus.pdf , site visited September						
		"THERMOELECTRICITY" website, http://www.nanothermel.org/public main.htm , site visit d July 28, 2003.						
	"Stacy Group" Stacy Group Thermoelectrics Research, website, http://www.cchem.berkeley. du/~amsgrp/thermoelectrics.html, site visited August 29, 2003.							
EXAMINER .	incip.iii vivi		DATE CONSIDERED		_			

^{*}EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

FORM PTO 1449 (modified) U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE LIST OF REFERENCES CITED BY APPLICANT(S) (Use several sheets if necessary)			ATTY DOCKET NO. 03650.002195. APPLICATION NO. N/Y/A						
			APPLICANT YOSHIMASA OKAMURA						
			FILING DATE HEREWITH GROUP N/Y/A						
			U.S. PATENT DO	CUMENTS			<u></u>		
*EXAMINER	DOCUMENT		OIST.TT.Z. V. DOGG.N.Z. V. V.				FILING DATE		
INITIAL	NUMBER	DATE		NAME	CLASS	SUBCLASS	IF APPROPRIATE		
	-						·		
		F(OREIGN PATENT	DOCUMENTS	1		TRANSLATION		
	DOCUMENT NUMBER	DATE		COUNTRY	CLASS	SUBCLASS	YES/NO/ OR ABSTRACT		
			·						
					-				
	L	OTHER DOCUMENT	(S) (Including Auth	or, Title, Date, Pertinent Pages, Etc.)					
"Design of Advanced Materials" Stacy Group Home, website, http://www.cchem.berkeley.edu/~amsgrp/index.html, site visited July 28, 2003.									
	"Eneco Technology" r-layout2, website, http://www.eneco-usa.com/technology/content.htm , site visited July 28, 2003.								
	Marlow Industries Inc." thermoelectric manufacturer Marlow Industries inc., website, http://www.marlow.com/, site visited July 28, 2003.								
	Hi-Z Technology" Hi-Z TECHNOLOGY, INC., website, http://www.hi-z.com/, site visited July 28, 2003.								
	"TELLUREX Z-Max thermoelectric modules for power generation" Tellurex Corporation, website, http://www.tellurex.com/ , site visited July 28, 2003.								
	"A Quantum Leap in Power Generation" Power Chips plc, website, http://www.powerchips.gi/ , site visited July 28, 2003.								
	"The Science Behind Power Chips TM , A Basic Introduction" Power Chips plc, website, http://www.powerchips.gi/technology/overview.shtml, site visited July 28, 2003.								
	M.S. Dresselhaus, et al., "INVESTIGATION OF LOW-DIMENSIONAL THERMOELECTRICS", Symposium Proceeding, Technomoic Publishing Co., pp. 1-13.								
	M.S. Dresselhaus, et al., "NANOWIRES FOR THERMOELECTRIC APPLICATIONS", Massachusetts Institute of Technology.								
EXAMINER	<u>,, </u>			CONSIDERED					

Sheet_3_ of _3_

^{*}EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.